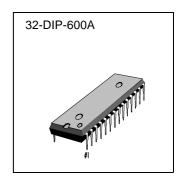
VIDEO AMP MERGED OSD PROCESSOR

The S1D2514X01 is a very high frequency video amplifier & wide range OSD processor 1 chip system with I^2C Bus control used in monitors. It contains 3 matched R/G/B video amplifiers with OSD processor and provides flexible interfacing to I^2C Bus controlled adjustment systems.



FUNCTIONS

- R/G/B video amplifier
- OSD processor
- I²C bus control
- · Cut-off brightness control
- R/G/B sub contrast/cut-off control
- Half tone

ORDERING INFORMATION

Device	Package	Operating Temperature		
S1D2514X01-D0B0	32-DIP-600A	-20 °C – +75 °C		

FEATURES

VIDEO AMP PART

- 3-channel R/G/B video amplifier, 150MHz @f-3dB
- I²C bus control items
 - Contrast control: -38dB
 - Sub contrast control for each channel: -12dB
 - Brightness control
 - OSD contrast control: -38dB
 - Cut-off brightness control (AC coupling)
 - Cut-off control for each channel (AC coupling)
 - Switch registers for SBLK and video half tone and CLP/BLK polarity selection and INT/EXT CLP selection
- Built in ABL (automatic beam limitation)
- · Built in video input clamp, BRT clamp
- Built in video half tone (3mode) function on OSD pictures
- Capable of 8.0Vp-p output swing
- Improvement of rise & fall time (2.2ns)
- Cut-off brightness control
- Built in blank gate with spot killer
- Clamp pulse generator
- OSD intensity
- · BLK, CLP polarity selection
- Clamp gate with anti OSD sagging

OSD PART

- Built in 1K-byte SRAM
- 256 ROM fonts (each font consists of 12×18 dots.)
- Full screen memory architecture
- Wide range PLL available (15kHz 90kHz, Reference 800 X 600)
- Programmable vertical height of character
- Programmable vertical and horizontal positioning
- Character color selection up to 16 different colors (in a units of character)
- Programmable background color (up to 16 colors)
- · Character blinking and shadowing
- Character scrolling
- 72MHz pixel frequency from on-chip PLL (Reference 800 ± 600)
- Full white pattern generation function



BLOCK DIAGRAM

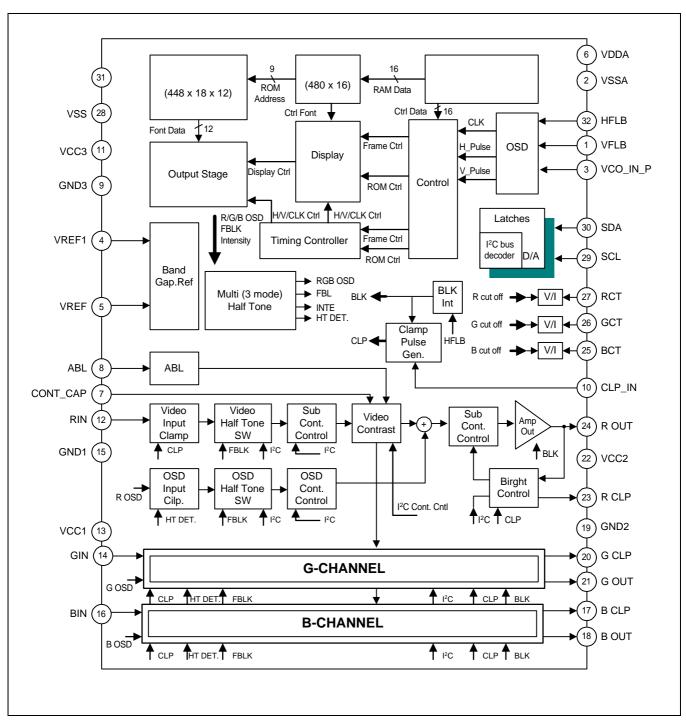


Figure 1. Functional Block Diagram

PIN CONFIGURATION

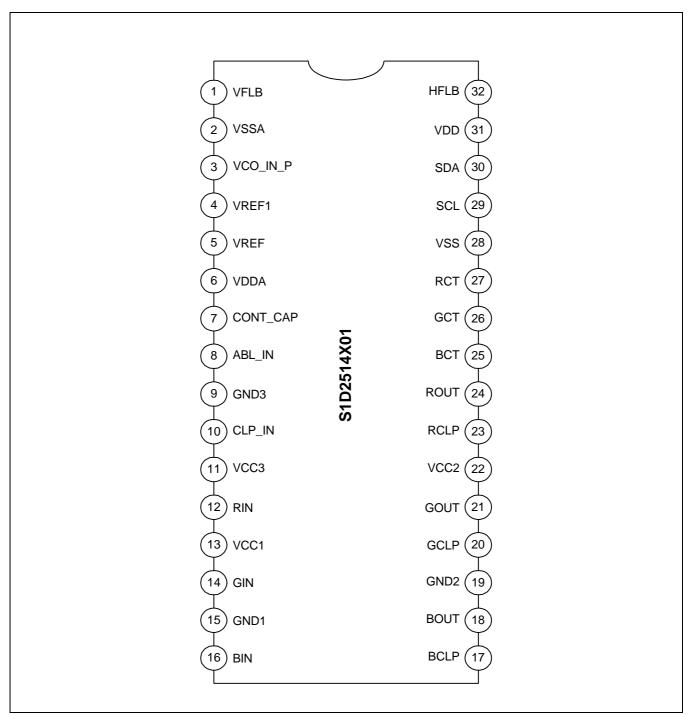


Figure 2. Pin Configuration

Table 1. Pin Configuration

Pin No.	Symbol	I/O	Configuration
1	VFLB	I	Vertical flyback signal
2	VSSA	-	Ground (PLL part)
3	VCO_IN_P	I	This voltage is generated at the external loop filter and goes into the input stage of the VCO.
4	VREF1	0	Charge pump output
5	VREF	0	PLL regulator filter
6	VDDA	-	+5V supply voltage for PLL part
7	CONT_CAP	-	Contrast control for AMP part
8	ABL	-	Auto beam limit.
9	GND3	-	Ground for video AMP part(for AMP control)
10	CLP_IN	-	Video clamp pulse input
11	VCC3	-	+12V supply voltage for video AMP part(for AMP control)
12	RIN	1	Video signal input (red)
13	VCC1	-	+12V supply voltage for video AMP(for main video signal process)
14	GIN	1	Video signal input (green)
15	GND1	-	Ground for video AMP part(for main video signal process)
16	BIN	I	Video signal input (blue)
17	BCLP	-	B output clamp cap
18	BOUT	0	Video signal output (blue)
19	GND2	-	Ground for video AMP part(for video output drive)
20	GCLP	-	G output clamp cap
21	GOUT	0	Video signal output (green)
22	VCC2	-	+12V supply voltage for video AMP part(for video output drive)
23	RCLP	-	R output clamp cap
24	ROUT	0	Video signal output (red)
25	ВСТ	-	B cut-off output
26	GCT	-	G cut-off output
27	RCT	-	R cut-off output
28	VSS	-	Ground for digital part
29	SCL	I	Serial clock (I ² C)
30	SDA	I/O	Serial data (I ² C)
31	VDD	-	+5V supply voltage for digital part
32	HFLB	I	Horizontal flyback signal

PIN DESCRIPTION

Table 2. Pin Description

Pin No	Pin Name	Schematic	Description
1	VFLB	VFLB V	FLB signal is in TTL level
32	HFLB	HFLB	Multi polarity input
3	VCO_IN_P	ζ,	PLL loop filter output
4	VPEF1		BandGap ref. output
5	VREF	↓	
7	Contrast cap (CONT_CAP)	I ² C Data > 4.0K Vref	Contrast cap range (0.1uF — 5uF)
8	ABL_IN	VCC 100K Vref Vref Vref 250μA	ABL input DC range (1 — 4.5V)



Table 2. Pin Description (Continued)

Pin No	Pin Name	Schematic	Description
10	CLP_IN	VCC	Multi polarity input Clamp gate pulse TTL level input
12	Red video input (RIN)	vcc vcc	Max input video signal is 0.7 Vpp
14	Green video input (GIN)	*	
16	Blue video input (BIN)	Video_In 0.2K W→ 12K	
17	Blue (B clamp cap)	Ţ	Brightness controlling actives by charging and discharging of the
20	Green (G clamp cap)	0.2K \$ CLP	external cap. (0.1μF) (During clamp gate)
23	Red (R clamp)	0.2K ₹ Iclamp	

Pin No **Pin Name Schematic Description** 18 Blue video output Video signal output VCC (BOUT) 0.05K 21 Green video output 0.5K -∕√√— (GOUT) 0.04K Video_Out 24 Red video output sink 🌓 (ROUT) 27 Red cut-off control Cut-off control output -Х стх (RCT) 26 Green cut-off control (GCT) 0-**6**00uA **φ**-200uA 50uA 25 Blue cut-off control (BCT) 29 SCL Serial clock input port of I²C bus 30 **SDA** Serial data input port of I²C bus

Table 2. Pin Description (Continued)



ABSOLUTE MAXIMUM RATINGS (see 1)

(Ta = 25 °C)

Table 3. Absolute Maximum Ratings

No	Item	Value	Symbol				Unit
NO	itein	Symbol	Min	Тур	Max	Oilit	
1	Maximum supply voltage	V _{CC}	-	-	13.2	V	
'	waximum supply voltage	V _{DD}	-	-	6.5	V	
2	Operating temperature (see 2)	Topr	-20	-	75	°C	
3	Storage temperature	Tstg	-65		150	°C	
4	Operating supply voltage	V _{CCop}	11.4	12.0	12.6	√ (see 3)	
_	Operating Supply Voltage	V _{DDop}	4.75	5.00	5.25	V	
5	Power dissipation	P _D	-	-		W	

THERMAL & ESD PARAMETER

Table 4. Thermal & ESD Parameter

No	Item	Symbol	Value			Unit
NO	itein	Symbol	Min	Тур	Max	Oille
1	Thermal resistance (junction-ambient)	θја	-	48	-	°C/W
2	Junction temperature	Tj	-	150	-	°C
3	Human body model (C = 100p, R = 1.5k)	НВМ	2	-	-	KV
4	Machine model (C = 200p, R = 0)	MM	300	-	-	V
5	Charge device model	CDM	800	-	-	V

ELECTRICAL CHARACTERISTICS

DC ELECTRICAL CHARACTERISTICS

 $(Tamb = 25 \, ^{\circ}C, \, V_{CC} = 12V, \, V_{DD} = V_{DDA} = 5V, \, ABL \, input \, voltage = 5V, \, HFLB \, input \, signal = S3, \, load \, resistors = 470\Omega, \, except \, OSD \, part \, current \, 35mA, \, unless \, otherwise \, stated)$

Table 5. DC Electrical Characteristics

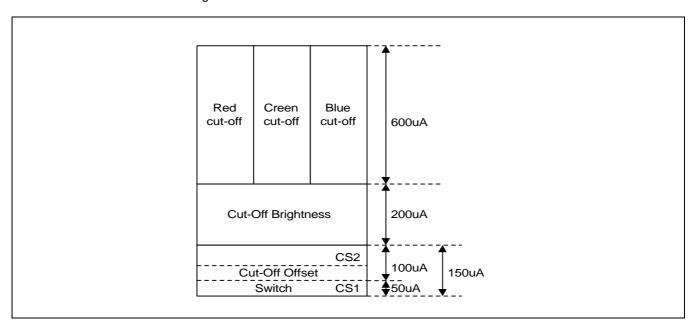
Description	Comple al	Conditions		Value		I I m i t
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Supply current	I _{CC} (see 4)		100	125	130	mA
Minimum supply current	I _{CC} min	V _{CC} = 11.4V	95	110	120	mA
Maximum supply current	I _{CC} max	V _{CC} = 12.6V	105	130	140	mA
ABS supply current	I _{CC} abs	V _{CC} = 13.2V	-	-	175	mA
Video input bias voltage	V bias		1.8	2.1	2.4	V
Video black level voltage (POR)	V blackpor		1.20	1.50	1.80	V
Black level voltage channel difference (POR)	Δ V blackpor (see 5)		Δ 10	-	-	%
Video black level voltage (FFH)	V blackff	04 = FFH ^(see 13)	2.2	2.7	3.2	V
Black level voltage channel difference (FFH)	Δ V blackff		Δ 10	-	-	%
Video black level voltage (00H)	V black00	04 = 00H	-	0.2	0.5	V
Black level voltage channel difference (00H)	Δ V black00		Δ 10	-	-	%
Spot killer voltage	Vspot	V _{CC} = Var.	9.20	10.4	11.2	V
Cut-off current (FFH)	ICTff	Pin25, 26, 27 = 12V 09 — 0B: FFH 0C: 00H	500	625	750	μА
Cut-off current (00H)	ICT00	Pin25, 26, 27 = 12V 09 — 0C: 00H	-	2.0	5.0	μА
Cut-off brightness current (FFH)	ICTBRTff	Pin25, 26, 27 = 12V 09 — 0B: 00H 0C: FFH	100	180	260	μА
Cut-off brightness current (80H)	ICTBRT80	Pin25, 26, 27 = 12V 50 90 09 — 0B: 00H 0C: 80H		90	130	μА
Cut-off offset current 1	ICS1	Pin25, 26, 27 = 12V 09 — 0C: 00H 0E: 11H	25	50	75	μА



Table 5. DC Electrical Characteristics (Continued)

Parameter	Symbol	Conditions	Value			Unit
raiametei	Symbol	Conditions	Min	Тур	Max	Oiiit
Cut-off offset current 2	ICS2	Pin25, 26, 27 = 12V 09 — 0C: 00H 0E: 12H	50	100	130	μΑ
Soft BLK output voltage	Vsblk	0D: 80H 0E: 14H	-	0.2	0.5	V
Clamp cap voltage (POR)	Vcap		6.0	7.0	8.0	V

Total external cut-off current range



AC ELECTRICAL CHARACTERISTICS

(Tamb = 25 °C, V_{CC} = 12V, V_{DD} = V_{DDA} = 5V, ABL input voltage = 5V, HFLB input signal = S3, load resistors = 470 Ω , Vin = 0.7Vpp manually adjust video output pins 18, 21 and 24 to 4V DC for the AC test (see 11) unless otherwise stated (see 12))

Table 6. AC Electrical Characteristics

Parameter	Symbol	ol Conditions		Value		
Farameter	Symbol	Conditions	Min	Тур	Max	Unit
Contrast max. output voltage	Vcff	03, 05, 06, 07 = FFH	5.0	5.7	6.4	Vpp
Contrast max. output channel difference	Δ Vcff	04, 08 — 0C = 80H RGB input = S1	Δ10	-	-	%
Contrast center output voltage	Vc80	03, 04, 08 — 0C = 80H	2.5	2.85	3.2	Vpp
Contrast center output channel difference	Δ Vc80	05, 06, 07 = FFH RGB input = S1	Δ10	-	-	%
Contrast max Center attenuation	С	C = 20log (Vc80/Vcff)	-8	-6	-4	dB
Sub contrast center output voltage	Vd80	03 = FFH	2.3	2.6	2.9	Vpp
Sub contrast center output channel difference	Δ Vd80	04 — 0C = 80H RGB input = S1	Δ 10	-	-	%
Sub contrast min. output voltage	Vd00	03 = FFH, 05— 07: 00H	1.3	1.6	1.9	Vpp
Sub contrast min. output channel difference	Δ Vd00	04, 08 — 0C = 80H RGB input = S1	Δ 10	-	-	%
Sub contrast max min. attenuation	D	D = 20log (Vd00/Vcff)	-14	-12	-10	dB
ABL control range	ABL	(see 15)	-12	-10	-8	dB
R/G/B video rising time (see 7)	tr (video)	03, 05 — 07: FFH	-	2.2	2.8	ns
R/G/B video falling time (see 7)	tf (video)	- 04, 08 — 0C: 80H RGB input = S2	-	2.2	2.8	ns
R/G/B blank output rising time (see 7)	tr (blank)	POR	-	6.0	12.0	ns
R/G/B blank output falling time (see 7)	tf (blank)	- HFLB: S4	-	8.0	15.0	ns
R/G/B video band width (see 7, 8)	f (-3dB)	(see 16)	150	-	-	MHz
Video AMP 50MHz cross talk	CT_50M (see7, 9)	(see 17)	-	-25	-20	dB
Video AMP 130MHz cross talk	CT_130M (see7, 9)	(see 18)	-	-15	-10	dB
Absolute gain match	Avmatch (see 6)		-1	-	1	dB
Gain change between amplifier	Avtrack (see 7)		-1	-	1	dB



OSD ELECTRICAL CHARCTERISTICS

(Tamb = 25 °C, V_{CC} = 12V, V_{DD} = V_{DDA} = 5V, HFLB input voltage = S3, load rosistors = 470 Ω , V-AMP test registors FBLK, OSD input conditions unless otherwise stated)

Table 7. OSD Electrical Chaacteristics

Parameter	Cumbal	Conditions	Value			Unit	
rarameter	Symbol	Conditions	Min	Тур	Max		
OSD contrast max. output voltage	Vocff	08 = FFH	5.4	6.4	7.4	Vpp	
OSD contrast max. output channel difference	Δ Vocff	OSD RGB output conditions	Δ 10	-	-	%	
OSD contrast center output voltage	Voc80	08 = 80H	2.7	3.2	3.7	Vpp	
OSD contrast center output channel difference	Δ Voc80	OSD RGB output conditions	Δ 10	-	-	%	
R/G/B OSD rising time	tr (OSD)	08: FFH	-	4.0	5.0	ns	
R/G/B OSD falling time	tf (OSD)		-	4.0	5.0	ns	
HT video level	HTvideo	ABL = 6V	-6.0	-4.5	-3.0	dB	
HT video output channel difference	Δ HTvideo	RGB input = S1 03, 05 — 08: FFH 0D: 01H OSD black conditions input HTvideo = 20log(V _{htvideo} /V _{cff})	Δ15	-	-	%	
HT OSD level	HTosd	ABL = 6V	-7.0	-5.5	-4.0	dB	
HT OSD output channel difference	Δ HTosd	05 — 08: FFH 0D: 0FH OSD white condition input HTosd = 20log (V _{htosd} /V _{ocff})	Δ15	-	-	%	

OPERATION TIMINGS

Table 8. Operation Timings

Parameter	Symbol	Min	Тур	Max	Unit
Input Signal HFLB, VFLB	•		•		
Horizontal flyback signal frequency	f _{HFLB}	-	-	120	kHz
Vertical flyback signal frequency	f _{VFLB}	-	-	200	Hz
I ² C Interface SDA, SCL (Refer to Figure	re 3)				
SCL clock frequency	f _{SCL}	-	-	300	kHz
Hold time for start condition	t _{hs}	500	-	-	ns
Set up time for stop condition	t _{sus}	500	-	-	ns
Low duration of clock	t _{low}	400	-	-	ns
High duration of clock	t _{high}	400	-	-	ns
Hold time for data	t _{hd}	0	-	-	ns
Set up time for data	t _{sud}	500	-	-	ns
Time between 2 access	t _{ss}	500	-	-	ns
Fall time of SDA	t _{fSDA}	-	-	20	ns
Rise time of both SCL and SDA	t _{rSDA}	-	-	-	ns

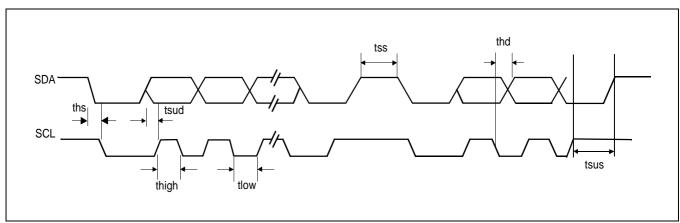


Figure 3. I²C Bus Timing Diagram



OSD PART DC ELECTRICAL CHARACTERISTICS

 $(Ta = 25 C, V_{DDA} DD = 5V)$

Parameter	Symbol		Тур	Max	
Supply voltage	V	4.75	5.00		V
Supply current	I _{DD}		-	25	
Input voltage	V	0.8V _{DD}		-	V
	IL	-		V _{SS}	V
Output voltage	ОН	0.8V	-	-	
±1mA)	V _{OL}		-	V + 0.4	V
	I _{IL}		-	10	А
VCO input voltage	VCO		2.5		

NOTES:

- 1. Absolute maximum rating indicates the limit beyond which damage to the device may occur.
- Operating ratings indicate conditions for which the device is functional but do not guarantee specific performance limits.
 For guaranteed specifications and test conditions, see the electrical characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- VCC supply pins 11, 13, and 22 must be externally wired together to prevent internal damage during VCC power on/off cycles.
- The supply current specified is the quiescent current for VCC1/VCC2 and VCC3 with RL = ∞, The supply current for VCC2 (pin 22) also depends on the output load.
- 5. Output voltage is dependent on load resistor. Test circuit uses $RL = 470\Omega$
- 6. Measure gain difference between any two amplifiers Vin = 700mVpp.
- 7. When measuring video amplifier bandwidth or pulse rise and fall times, a double sided full ground plane printed circuit board without socket is recommended. Video amplifier 50MHz cross talk test also requires this printed circuit board. The reason for a double sided full ground plane PCB is that large measurement variations occur in single sided PCBs.
- 8. Adjust input frequency from 10MHz (AV max reference level) to the -3dB frequency (f -3dB).
- Measure output levels of the other two undriven amplifiers relative to the driven amplifier to determine channel separation.
 Terminate the undriven amplifier inputs to simulate generator loading. Repeat test at fin = 50MHz for cross talk 50MHz.
- 10. A minimum pulse width of 200 ns is guaranteed for a horizontal line of 15kHz. This limit is guaranteed by design. if a lower line rate is used a longer clamp pulse may be required.
- 11. During the AC test the 4V DC level is the center voltage of the AC output signal. For example. If the output is 4Vpp the signal will swing between 2V DC and 6V DC.
- 12. These parameters are not tested on each product which is controlled by an internal qualification procedure.
- 13. The conditions blocks 03, 04, 05... etc. signify sub address'0F03, 0F04, 0F05... etc.
- 14. Sub address 0F03, 0F05 0F07: FFH 0F04, 0F08 0F0C: 80H

RGB input = S1,

When the ABL input voltage is 0V, the R/G/Bs output voltage is VR/VG/VB and uses the formula ABLR = 20log (VR/V cffR)

15. OSD TST mode = High, CLP operation off,

```
RGB input = S5 (frequency sweep),
```

RGB input clamp cap = 2.1V DC,

RGB clamp cap (pin 23/20/17) = Vcap voltage (7.0V),

S5s frequency 1MHz \rightarrow 130MHz sweep, -3dB point = 20log (V_{130MHz}/V_{1MHz})

03, 05 — 07: FFH

04, 08 — 0C: 80H

0F: 80H

16. OSD TST mode = High, CLP operation off,

RGB input clamp cap = 2.1V DC,

RGB clamp cap (pin 23/20/17) = Vcap voltage (7.0V),

03, 05 — 07: FFH

04, 08 — 0C: 80H

0F: 80H

R input = S5 (50MHz)

 $CT_50M = 20log (V_{outG}/V_{outR}) or 20log (V_{outB}/V_{outR})$

17. OSD TST mode = High, CLP operation off,

RGB input clamp cap = 2.1V DC,

RGB clamp cap (pin 23/20/17) = Vcap voltage (7.0V),

03, 05 — 07: FFH

04, 08 — 0C: 80H

0F: 80H

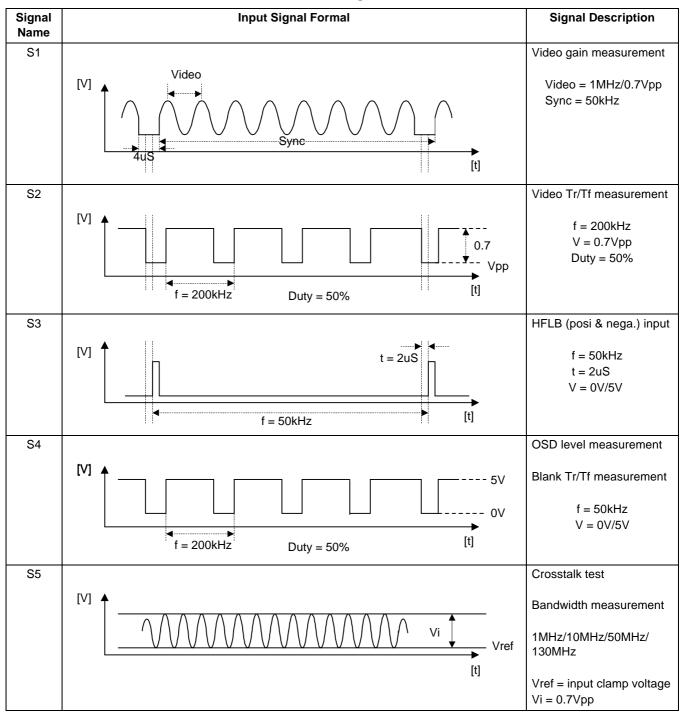
R input = S5 (130MHz)

 $CT_150M = 20log (V_{outG}/V_{outR}) or 20log (V_{outB}/V_{outR})$



TEST SIGNAL FORMAT

Table 10. Test Signal Format



- S1, S2 signals low level must be synchronized with the S3 signals sync. term.
- The input signal level uses the IC pin as reference.



TEST CIRCUIT

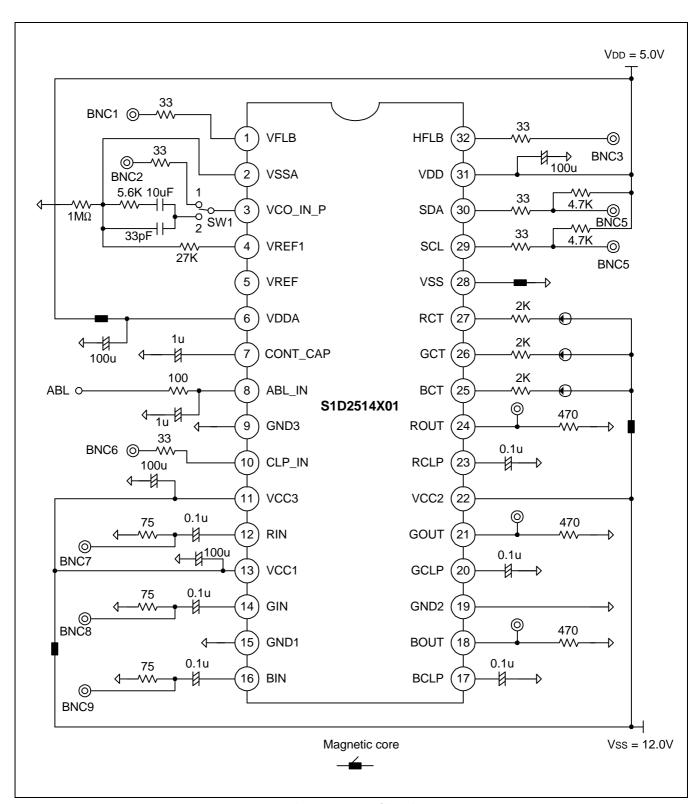


Figure 4. Test Circuit



FUNCTIONAL DESCRIPTIONS

DATA TRANSMISSION

The interface between S1D2514X01 and MCU follows the I^2C protocol. After the starting pulse, the transmission takes place in the following order: Slave address with R/W bit, 2-byte register address, 2-byte data, and stop condition. an acknowledge signal is received for each byte, excluding only the start/stop condition. The 2-byte register address is composed of an 8-bit row address, and an 8-bit column address. The order of transmission for a 2-byte register address is 'Row address \rightarrow Column address'. The 2 bytes of data is because S1D2514X01 has a 16-bit base register configuration. S1D2514X01's slave address is BAh. It is BBh in read mode, and BAh in write mode.

• Address Bit Pattern for Display Registers Data

(a) row address bit pattern

R3 - R0: Valid data for row address

Α	15	A14	A13	A12	A11	A10	A9	A8
	<	Х	Х	Х	R3	R2	R1	R0

(b) Column address bit pattern

C4 - C0: Valid data for column address

A7	A6	A5	A4	А3	A2	A1	A0
Х	Х	Х	C4	C3	C2	C1	C0

X:Don't care bit

• Data Transmission Format

 $Start \rightarrow Slave \ address \rightarrow ACK \rightarrow Row \ address \rightarrow ACK \rightarrow Column \ address \rightarrow ACK$ Data byte N \rightarrow ACK \rightarrow Data byte N+1 \rightarrow ACK \rightarrow Stop

Figure 5. Data Transmission Format at Writing Operation

 $Start \rightarrow Slave \ address \rightarrow ACK \rightarrow Row \ address \rightarrow ACK \rightarrow Column \ address \rightarrow ACK \rightarrow Stop \\ Start \rightarrow Slave \ address \rightarrow ACK \rightarrow Data \ byte \ N \rightarrow ACK \rightarrow Data \ byte \ N+1 \rightarrow ACK \rightarrow Stop$

Figure 6. Data Transmission Format at Reading Operation



SDA / SCL Signal At Communication

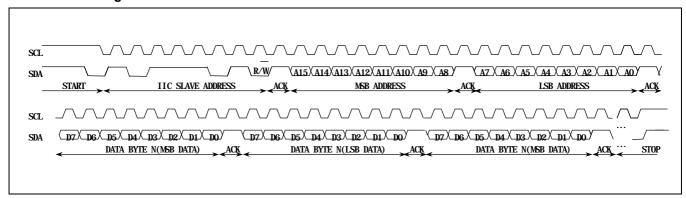


Figure 7. SDA line and SCL line (Write Operation)

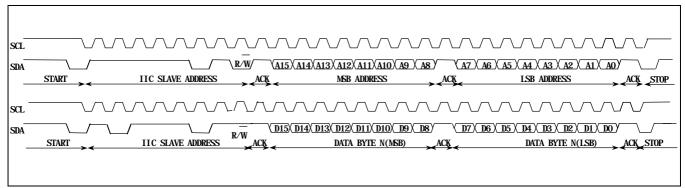


Figure 8. SDA line and SCL line (Read Operation)



MEMORY MAP

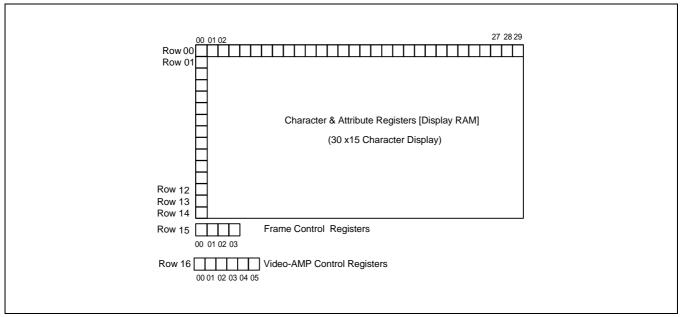


Figure 9. Memory Map of Display Registers

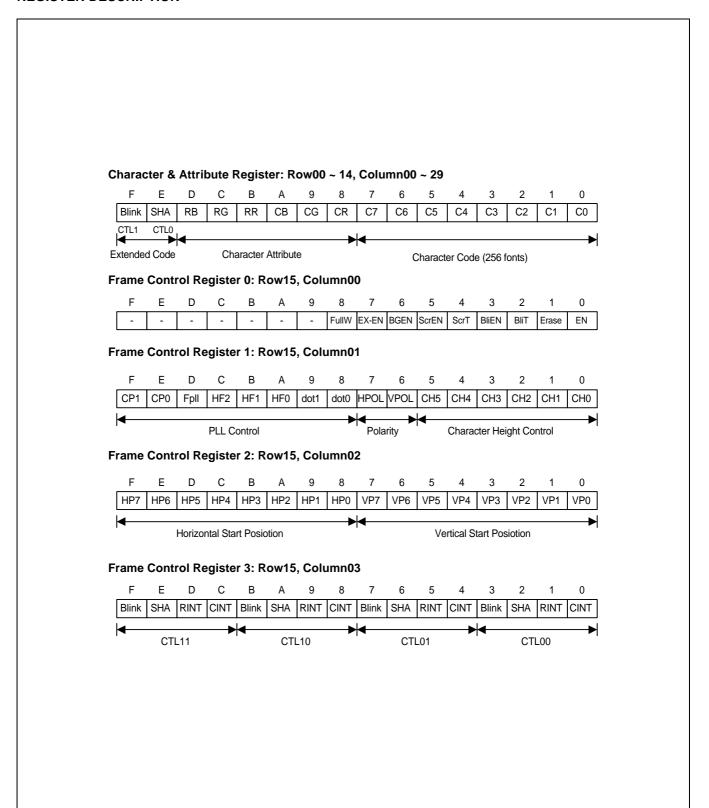
The display RAM's address of the row and column number are assigned in order. The display RAM is composed of 3 register groups (character & attribute register, frame control register and V-AMP control register).

The display area in the monitor screen is 30 column \times 15 row, so the related character & attribute registers are also 30 column \times 15 row. Each register has a character address and characteristics corresponding to the display location on the screen, and one register is composed of 16 bits. The lower 8 bits select the font from the 256 ROM fonts, and the upper 8 bits give font characteristics to the selected font.

The frame control registers are in the 16th row. It controls OSD's display location, character height and scroll in units of frame.

The V-AMP control registers are also located in the 17th row.

REGISTER DESCRIPTION





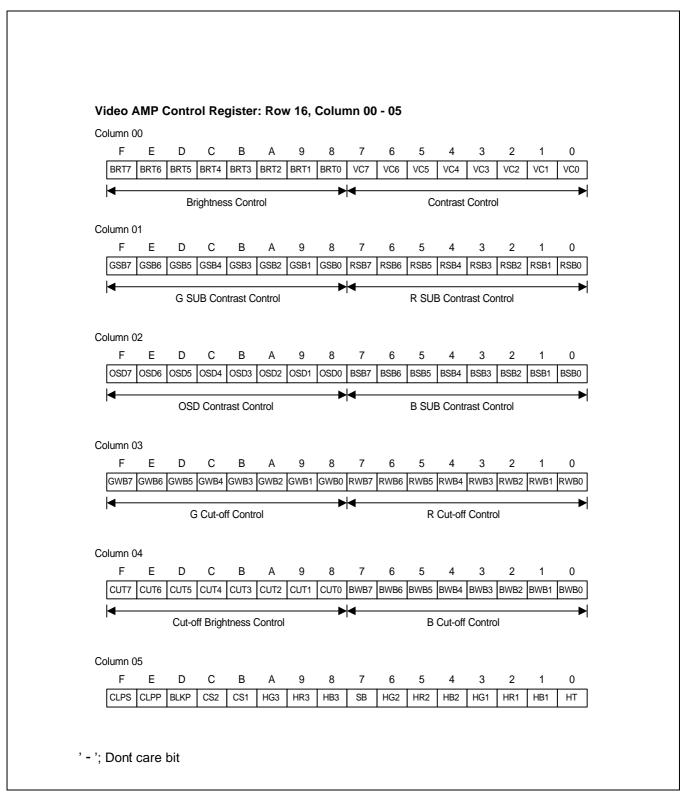


Figure 10. Register Description

Table 11. Register Description

Registers	Bits	Description
Character &	C7 — C0	Character code address
Attribute Registers	(Bit 7 — 0)	This is the address of 256 ROM fonts.
(Row 00 ~ 14,	CB, CG, CR	Character color
Column 00 ~ 29)	(Bit A — 8)	The character color is chosen from 16 colors using these 3 bits and the frame control register 3s CINT bit.
	RB, RG, RR	Raster color is determined by these bits.
	(Bit D — B)	The raster color is chosen from out of 16 colors using these 3 bits and the frame control register 3s RINT bit.
	SHA / CTL0	Character shadowing / CTL0(Extended Code)
	(Bit E)	If you set the frame control register 0's EX-EN bit to '0', this bit carries out character shadowing feature.(If SHA bit is '1', the character shadowing is shown)
		If you set the frame control register 0's EX-EN bit to '1', this bit is used for extended code.
	Blink / CTL1	Character blinking / CTL1(Extended Code)
	(Blt F)	If you set the frame control register 0s EX-EN bit to '0', this bit carries out character blinking feature.(If Blink bit is '1', the character blinking feature is shown)
		If you set the frame control register 0s EX-EN bit to '1', this bit is used for extended code.

If you set the Frame Control Register 0's 'EX-EN' bit as '1', the Character & Attribute Register's 'SHA' and 'Blink' bits are used to call the Extended Code.

In other words, the combination of SHA and Blink bits can call four kind Extended Code 'CTL00', 'CTL01', 'CTL10' and 'CTL11', the CINT, RINT, SHA and Blink features can be carried out in a unit of character fonts.



Table 11. Register Description (Continued)

Registers	Bits	Description							
Frame Control	EN	OSD enable							
Registers - 0	(Bit 0)	OSD is enabled when this bit is '1'. In other words, if this bit isn't '1'OSD is not output inspite of writing control data. We recommend that you enable							
(Row15, Column00)		the OSD after setting the control registers (such as the character & attribute							
		register) because of video and OSD output timing.							
	Erase	RAM erasing							
	(Bit 1)	If this bit is '1', the RAM data (character & attribute registers) is erased. The time spent in carrying out this operation is called erasing time, which can be calculated as follows.							
		Erasing time = RAM clock × 480 (RAM cell no.)							
		RAM clock = 12 dot clock							
		Dot clock = 1/(dot frequency)							
		Dot frequency = Horizontal frequency × resolution (mode)							
		Therefore, the maximum erasing time value is:							
		(Erasing Time) _{MAX} = $(12 \times 480) / (15k \times 320) = 1.2ms$							
	BliT	Blink time control							
	(Bit 2)	If this bit is '1', blink time is 0.5sec, and if not, 1sec.							
	BliEN	Blinking enable							
	(Bit 3)	Blinking effect is controlled by this bit.							
		If this bit is 1, blinking effect is enabled.							
		If this bit is '0', a full OSD screen blinking effect is disabled.							
	ScrT	Scroll time control							
	(Bit 4)	If this bit is '1', scroll time is 0.5sec, and if not, 1sec.							
	ScrEN	Scroll enable							
	(Bit 5)	Scrolling effect is controlled by this bit. If this bit is '1', scrolling effect is enabled. You must remember that scrolling can be turned on/off only when OSD is enabled/disabled.							
	BGEN	Back ground enable							
	(Bit 6)	If the BGEN bit is '1' and the raster color is black, the raster is transparent.							
		That is, the video back ground is shown. If not, the OSD raster covers the video's back ground. Refer to other color effect.							
	EX-EN	Extended code enable							
	(Bit 7)	If the EX-EN bit is '1', the Character & Attribute registers Blink, SHA bits carry out Extended Code features instead of Blink and SHA features.							
	FullW	Full white pattern enable							
	(Bit 8)	If the FullW bit is '1', the full white pattern is displayed in the screen.							

Table 11. Register Description

Registers	Bits									
Frame Control	CH5 — CH0	Character	height co	ontrol						
Registers - 1		While the	ourpose (of VZ[1:0] (ver	tical characte	er height) is to control the				
Column01)		to output OSD of a uniform size even if the resolution changes. If you the value in the range of CH = 18 ~ CH = 63, each line's repeating line is repeated. For more information on repeating number selection to character height.								
		Polarity of	vertical f	ly back signal						
	(Bit 6)		L:4 :		h:h	Markey Law				
				t to '1' if active		if active low.				
	HPOL	_		al fly back sign						
		If this bit is	'1', HFL	B's polarity is p	positive, and	if '0', it is negative. In other				
	dot1, dot0 (Bit 9, 8)									
	, , ,	Dot1	Dot0							
		0	0							
		0	1							
		1	0							
		1	1							
		As shown combination			lots per horiz	contal line is decided by a				
		Horizontal	frequenc	у						
	(Bit C — A)									
		This is related to the selection of DOT[1:0], so you can't numerically express the frequency range with only the HF[2:0] selection. For more								
	FPLL									
	(Bit D)	rates at full range (4.8MHz - decided by the HF bit [C:A]								
		the high re	gion, you	u may set the F	FPLL bit to '1	1.				



Table 11. Register Description (Continued)

Registers	Bits			Description								
Frame Control	CP1, CP0	Charge pu	Charge pump output current control									
Registers - 1 (Row15, Column01)	(Bit F, E)		This is the PLL block's internal phase detector output status, converted into current. Refer to PLL control.									
Coldinino 1)		CP1	CP1 CP0 Charge Pump Current									
		0	0	0.50 mA								
		0	1	0.75 mA								
		1	0	1.00 mA								
		1	1	1.25 mA	1							
		The output is decided by the combination of these two bits.										

The purpose of bits 'HPOL', and 'VPOL' is to provide flexibility when using the S1D2514X01 IC. No matter which polarity you choose for the input signal, the IC will handle them identically, so you can select active high or active low according to your convenience.

Tabel 4. Register Description (Continued)

Registers	Bits	Description
Frame Control	VP7 — VP0	Vertical start position control (= VP[7:0] × 4)
Registers - 2	(Bit 7 — 0)	Signifies top margin height from the V-Sync reference edge.
(Row 15,	HP7 — HP0	Horizontal start position control (= $HP[7:0] \times 6$)
Column 02)	(Bit F — 8)	Signifies delay of the horizontal display from the H-Sync reference edge to the character's 1st pixel location.
Frame Control	CTL 00	Extended code
Registers - 3 (Row 15,	(Bit 3 — 0)	In case the EX-EN bit is '1' and the Character & Attribute registers E and F bits are '0', these bits have meanings.
Column 03)		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.
	CTL 01	Extended code
	(Bit 7 — 4)	In case the EX-EN bit is 1'and the Character & Attribute registers E bit is '1' and F bit is '0', these bits have meanings.
		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.
	CTL 10	Extended code
	(Bit B — 8)	In case the EX-EN bit is '1' and the Character & Attribute registers E bit is '0' and F bit is '1', these bits have meanings.
		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.



Tabel 4. Register Description (Continued)

Registers	Bits	Description
Frame Control	CTL 11	Extended code
Registers - 3 (Row 15,	(Bit F — C)	In case the EX-EN bit is '1' and the Character & Attribute registers E and F bits are '1', these bits have meanings.
Column 03)		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.

Tabel 4. Register Description (Continued)

Registers	Bits	Description					
V-AMP Control Registers - 0	VC7 — VC0 (Bit7 — 0)	The contrast adjustment is made by controlling simultaneously the gain of three internal variable gain amplifiers.					
(Row 16,		The contrast adjustment allows to cover a typical range of 38dB.					
Column 00)	BRT7 — BRT0 (BitF — 8)	The brightness adjustment controls to add the same black level (pedestal) to the 3-channel R/G/B signals after contrast amplifier.					
V-AMP Control	RSB7 — RSB0	R channel SUB contrast control.					
Registers - 1 (Row 16,	(Bit7 — 0)	The SUB contrast adjustment is used to adjust the white balance, and the gain of each channel is controlled.					
Column 01)		The SUB contrast adjustment allows you to cover a typical tange of 12dB.					
	GSB7 — GSB0	G channel SUB contrast control.					
	(BitF — 8)	The SUB contrast adjustment is used to adjust the white balance, and the gain of each channel is controlled.					
		The SUB contrast adjustment allows you to cover a typical tange of 12dB.					
V-AMP Control	BSB7 — BSB0	B channel SUB contrast control.					
Registers - 2 (Row 16,	(Bit7 — 0)	The SUB contrast adjustment is used to adjust the white balance, and the gain of each channel is controlled.					
Column 02)		The SUB contrast adjustment allows you to cover a typical tange of 12dB.					
	OSD7 — OSD0 (BitF — 8)	The OSD contrast adjustment is made by controlling simultaneously the gain of three internal variable gain amplifiers.					
	,	The OSD contrast adjustment allows to cover a typical range of 38dB.					
V-AMP Control	RWB7 — RWB0	R channel cut-off control.					
Registers - 3	(Bit7 — 0)	The cut-off adjustment is used to adjust the raster white balance.					
(Row 16,	GWB7 — GWB0	G channel cut-off control.					
Column 03)	(BitF — 8)	The cut-off adjustment is used to adjust the raster white balance.					
V-AMP Control	BWB7 — BWB0	B channel cut-off control.					
Registers - 4	(Bit7 — 0)	The cut-off adjustment B used to adjust the raster white balance.					
(Row 16, Column 04)	CUT7 — CUT0 (BitF — 8)	The cut-off brightness adjustment is made by simultaneously controlling the external cut-off current.					
1	1						

Tabel 4. Register Description (Continued)

Registers	Bits				Des	cription					
V-AMP Control	HT	Video &	OSD hal	f tone er	nable.						
Registers - 5	(Bit 0)	If you se	t this bit	to '1', the	e half tor	ne functio	on is on.				
(Row 16,		Then you	ı can se	e the vid	eo signa	l & OSD	raster.				
Column 05)	HG1 — HB1	HG1 —	HB1 bit	s select (OSD ras	ter color	1 to be	half tone.			
	(Bit3 — 1)	To carry	out half	tone fun	ction, se	t the HT	bit to '1'				
		HG1 HR1 HB1 OSD Raster POR									
		HG1	HKI	HB1	G	R	В	Color 1	POR		
		0	0	0	0	0	0	Black	0		
		0	0	1	0	0	1	Blue			
		0	1	0	0	1	0	Red			
		0	1	1	0	1	1	Magenta			
		1	0	0	1	0	0	Green			
		1	0	1	1	0	1	Cyan			
		1	1	0	1	1	0	Yellow			
		1	1	1	1	1	1	White			
	HG2 — HB2 (Bit6 — 4)	HG2 ~ H To carry				t the HT					
		HG2	HR2	HB2		OSD		Raster Color 2	POR		
					G	R	В				
		0	0	0	0	0	0	Black	0		
		0	0	1	0	0	1	Blue			
		0	1	0	0	1	0	Red			
		0	1	1	0	1	1	Magenta			
		1	0	0	1	0	0	Green			
		1	0	1	1	0	1	Cyan			
		1	1	0	1	1	0	Yellow			
		1	1	1	1	1	1	White			
	SB	Soft blan	king ena	able							
	(Bit 7)	If you se	_		R/G/B ou	touts ao	to GND.				

Tabel 4. Register Description (Continued)

	Bits	Description										
Registers - 5 (Row 16,	HG3 — HB3 (BitA — 8)	To carry	out half	tone fund	ction, se	t the HT	bit to '1	' .				
(110W 10,			HR3	НВ3		_	I	Rast Colo				
			•		G	R						
		1	0		0	0		Blac				
		1		1	0		1	Blu	e			
			1	0		1	0					
		1	1		0	1		Mage				
		0	_	0	1	_	0	Gree				
		0	0	_	1	0	_	Суа				
		0		0	1		0	Yello	DW			
			1	1		1	1					
	CS2 — CS1	Cut-off offset current control										
		CS2	CS1		POR							
		0			,	100μ						
		0	1			μΑ						
			0			0 A			0			
			1			50 A						
	211/2	.										
	BLKP			ntral fly b	•		and if '1	1', it is po	oitivo			
				pulse sig		legalive,	anu ii i	i , it is po	Silive.			
	(Bit E)	Polarity	oi ciamp	puise sig	griai							
	(51. 2)	This bit h	nas mea	ning only	if the C	LPS bit i	s set to	'1'.				
	CLPS			eration e								
			_			de using	the HF	LB signa	l, so there is			
		and if '1'	you mus	st supply	externa	l clamp s	signal.					

VIDEO AMP PART ADDRESS MAP

Register sub address

Table 12. Video AMP Part Address Map

SUB		Function											POR									
Address [Hex]	F	Е	D	С	В	Α	9	8	7	6	5	4	3	2	1	0	Value [Hex]					
1000		Brightness control									С	ontras	t contr	control								
1001		SUB contrast control (G)								SUB contrast control (R)							8080					
1002			OSD) contr	ast co	ntrol			SUB contrast control (B)						8080							
1003			Cu	t-off co	ontrol	(G)			Cut-off control (R)						8080							
1004		(Cut-off	brigh	tness	contro	ol		Cut-off control (B)						8080							
1005	CLPS	CLPP	BLKP	CS2	CS1	HG3	HR3	НВ3	SB	HG2	HR2	HB2	HG1	HR1	HB1	HT	1800					

Contrast Register (SUB ADRS: 00H) (Vin = 0.7Vpp, bright: 80H, subcont: FFH)

Hex	B7	B6	B5	B4	В3	B2	B1	В0	Contrast (Vpp)	Gain (dB)	int. Value (Hex)
00	0	0	0	0	0	0	0	0	0	-	
80	1	0	0	0	0	0	0	0	2.85	-	0
FF	1	1	1	1	1	1	1	1	5.2	-	
			Inc	rement	/bit		0.0223				

Brightness Register (3-ch) (SUB ADRS: 00H) (cont: 80H, subcont: 80H)

Hex	В7	В6	B5	B4	В3	B2	B1	В0	Brightness (Vpp)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0	0.2	
80	1	0	0	0	0	0	0	0	1.5	0
FF	1	1	1	1	1	1	1	1	2.7	
			Inc	rement	/bit		0.01055			

SUB Contrast Register (R/G/B-ch) (SUB ADRS: 01/02H)

(Vin = 0.7Vpp, bright: 40H, cont: FFH)

Hex	В7	В6	B5	B4	В3	B2	B1	В0	SUB Contrast (Vpp)	Gain (dB)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0		-	
80	1	0	0	0	0	0	0	0		-	0
FF	1	1	1	1	1	1	1	1		-	
			Inc	rement	/bit						

OSD Contrast Register (SUB ADRS: 02H) (VOSD = TTL, bright: 80H, subcont: 80H)

Hex	В7	В6	B5	B4	В3	B2	B1	В0	OSD Contrast	Gain	Int. Value
									(Vpp)	(dB)	(Hex)
00	0	0	0	0	0	0	0	0	0	-	
80	1	0	0	0	0	0	0	0	3.2	-	0
FF	1	1	1	1	1	1	1	1	6.4	-	
			Inc	rement	/bit		0.025				

Cut-Off Brightness Register (3-ch) (SUB ADRS: 04H)

Hex	В7	В6	B5	B4	В3	B2	B1	В0	Cut-Off Brightness (μA)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0	0	
80	1	0	0	0	0	0	0	0	100	0
FF	1	1	1	1	1	1	1	1	200	
			Inc	rement	/bit		0.781			

Cut-Off Register (R/G/B-ch) (SUB ADRS: 03/04H)

(cont = 80H, subcont: 80H)

Hex	В7	В6	B5	B4	В3	B2	B1	B0	Cut-Off EXT (μA)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0	0	
80	1	0	0	0	0	0	0	0	300	0
FF	1	1	1	1	1	1	1	1	600	
			Inc	rement	/bit		2.344			



ADDRESSING

ROM Fonts

S1D2514X01 provides 256 Rom fonts for displaying OSD Icons, which allows the use of multi-language OSD Icons. Font \$000 is reserved for blank data.

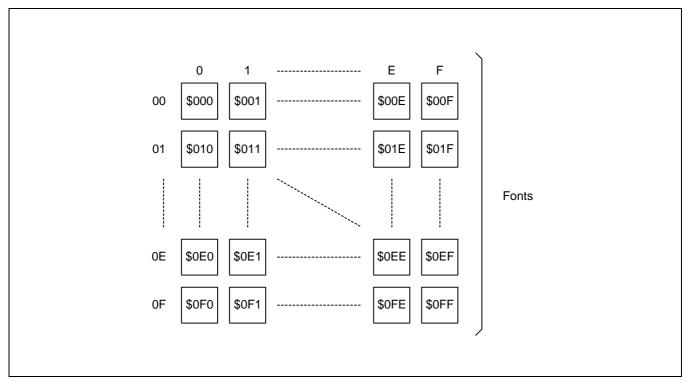


Figure 11. Composition of the ROM Fonts

COLORING

If you have an Intensity feature, the number of possible colors you can express becomes doubled. In other words, the number of colors you can represent with three colors blue, green, and red is 8 (= 2^3), but with the intensity feature, it is 16 (= 2^4).

Character Color

Character color is assinged for each font, and the 4 components for expressing a color are listed below.

Blue	Character & attribute register's CB bit[A]
Green	Character & attribute register's CG bit[9]
Red	Character & attribute register's CR bit[8]
Intensity	If the EX-EN bit is '1' and the Frame Control Register 3 CTLs CINT bit called by Character & Attribute registers Blink, SHA bits is '1', the character intensity feature is enabled.

Raster Color

Blue	Character & Attribute register's RB bit[D]
Green	Character & Attribute register's RG bit[C]
Red	Character & Attribute register's RR bit[B]
Intensity	If the EX-EN bit is '1' and the Frame Control Register 3 CTLs RINT bit called by Character & Attribute registers Blink, SHA bits is '1', the RASTER intensity feature is enabled.

According to the 'EX-EN', 'RINT' and 'CINT' bits setting, raster and character color intensity can be assigned in units of character.

Notes for When Making S1D2514X01 Fonts

Address 000h is appointed as blank data. RAM's initial values are all 0, and all bits are written as 0 when you erase the RAM, so blank data means the initial value. In other words, blank data means 'do nothing'. You don't need to write any data for the space font, except for 000h. It just needs to be an undotted area.



• Other Color Effet

The Frame Control Register 0 'BGEN' bit's function is shown in the Figure below. If you set the 'BGEN' bit as '0' after selecting A's raster color as black, the raster color black will be displayed. But if you set the 'BGEN' bit as '1', after selecting B's raster color as black, the raster color black becomes invisible, so the video back ground color (gray) is displayed as if it is the raster color.

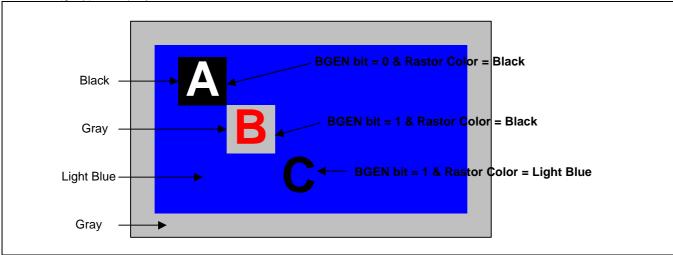


Figure 12. Color Effect by BGEN Bit



HEIGHT/POSITIONING

Character Height

The purpose of CH[5:0] (Character Height) is to output a uniformly sized OSD even if the resolution changes. To express a Character Height of CH = $18 \sim CH = 63$ after receiving CH[5:0]'s input from the frame control register-1, decide on each line's repeating number (Standard Height CH = 18) and repeat the lines.

The following Figure shows two examples of a height-controlled character. height control is carried out by repeating some of the lines.

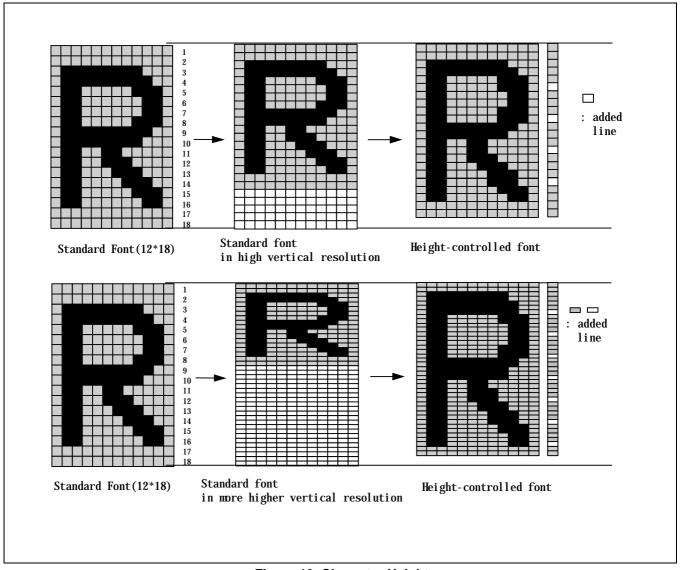


Figure 13. Character Height



Repeating line-number can be found by the following formula.

```
[# of the repeating lines = 2 + N \times M], where N = 1, 2, 3, ... and M = round{14 \, (CH[5:0]-18)}.
```

1. If CH[5:0] is greater than 32 and less than or equal to 46 (32 < CH[5:0] ≤ 46), all lines are repeated once or twice. The lines that are repeated twice are chosen by the following formula.

```
[# of the repeating lines = 2 + N \times M],
where N = 1, 2, 3, ... and M = round {14 \le (CH[5:0]-32)}.
```

2. If CH[5:0] is greater than 46 and less than or equal to 60 (46 < CH[5:0] ≤ 60), all lines are repeated two or three times. The lines that are repeated three times are chosen by the following formula.

```
[# of the repeating lines = 2 + N \times M], where N = 1, 2, 3, ... and M = round {14 \le (CH[5:0]-46)}.
```

3. If CH[5:0] is greater than 60 and less than or equal to 64 (60 < CH[5:0] ≤ 64), all Lines are repeated three or four times. The lines that are repeated four times are chosen by the following formula.

```
[# of the repeating lines = 2 + N \times M],
where N = 1, 2, 3, ... and M = round {14 \le (CH[5:0]-60)}.
```

CH's reference value is 18, and even if you input 0, it operates in the same way as when CH = 18. The repeating line-number is limited to 16. If the M value is less than or equal to 1, all lines of the standard font are repeated more than once.

Table 13. Repeating Line as Controlling by CH bits

Character Height	Repeating Line
CH = 18	-
CH = 19	9
CH = 20, 21	6, 13
CH = 22	5, 11, 17
CH = 23	4, 9, 14, 19
CH = 24	3, 7, 11, 15, 19, 21
CH = 25, 26, 27	3, 7, 11, 13, 15, 19, 22
CH = 28	3, 6, 9, 12, 14, 18, 20, 23, 25
CH = 29	3, 6, 9, 11, 13, 15, 18, 21, 23, 25, 26
CH = 30	3, 6, 8, 10, 12, 14, 16, 18, 20, 22, 25, 27
CH = 31	2, 5, 7, 9, 11, 13, 15, 17, 21, 23, 25, 27, 28
CH = 32, 33, 34, 35	2, 5, 7, 9, 11, 13, 15, 18, 21, 23, 25, 27, 28, 29
CH = 36	-
CH = 37	18

Table 13. Repeating Line as Controlling by CH bits

Character Height	Repeating Line (Continued)
CH = 38, 39	12, 25
CH = 40	10, 20, 30
CH = 41	8, 16, 24, 32
CH = 42	6, 12, 18, 24, 30, 36
CH = 43, 44, 45	6, 12, 18, 24, 30, 36, 41
CH = 46	4, 8, 12, 17, 21, 25, 29, 33, 37, 41
CH = 47	4, 8, 12, 16, 20, 24, 28, 32, 36, 40, 44
CH = 48	4, 8, 12, 16, 20, 23, 26, 29, 33, 37, 41, 45
CH = 49	4, 8, 12, 16, 19, 22, 25, 28, 31, 35, 39, 43, 47
CH = 50, 51, 52, 53	4, 8, 12, 15, 18, 21, 24, 27, 30, 33, 36, 40, 44, 48
CH = 54	-
CH = 55	27
CH = 56, 57	18, 36
CH = 58	14, 28, 42
CH = 59	12, 23, 34, 45
CH = 60	9, 18, 26, 34, 43, 52
CH = 61, 62, 63	8, 16, 23, 30, 37, 44, 51

Positioning

The frame control register-2's HP Bit [F:8] signifies delay of the horizontal display from the H-Sync reference edge to the character's 1st pixel location, and is controlled by multiplying HP [F:8]'s range value by 6. Also, VP bit[7:0] signifies the top margin height from the V-Sync reference edge, and is controlled by multiplying 4 to the VP [7:0]'s range value. Refer to the Figure shown below.

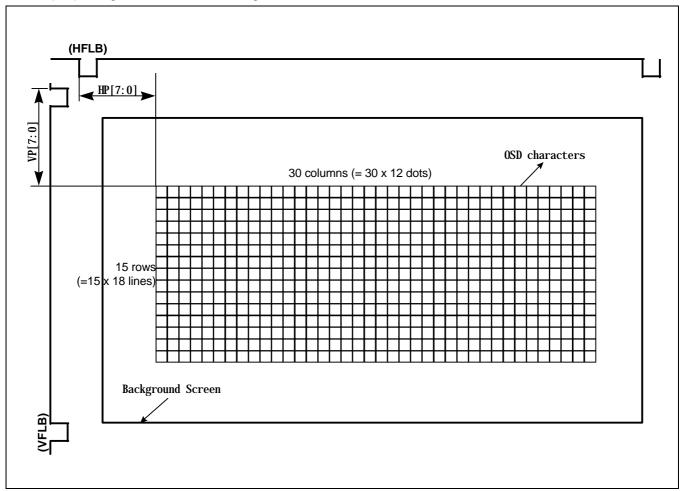


Figure 14. Frame Composition with the OSD Characters

VISUAL EFFECTS

Shadowing

The character shadow can only be black. Character shadow is making 1 pixel to the right and below the character.

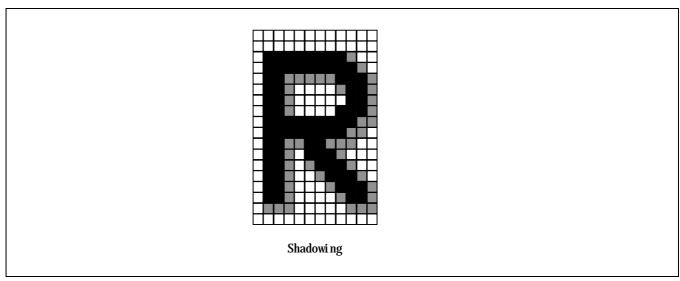


Figure 15. Character Shadowing

Scrolling

Scrolling is slowly displaying or erasing a character from the top line to the bottom. This effect makes it look as if 1 character line is scrolling up or down. asharacter line is scrolling up or down.

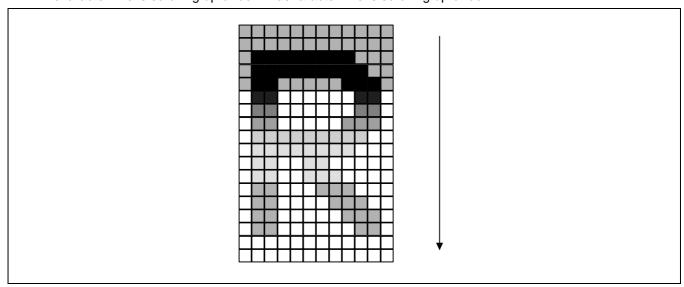


Figure 16. Scrolling

PLL CONTROL

Introduction

PLL (Phase Lock Loop) is feedback controlled circuit that maintains a constant phase difference between a reference signal and an oscillator output signal.

Generally, PLL is composed as follow Figure.

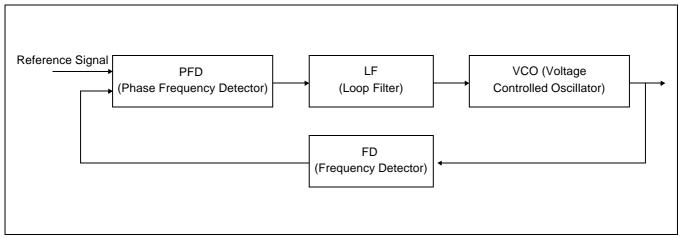


Figure 17. Block Diagram of General PLL

- PFD (Phase Frequency Detector)

PFD compares the phase of the VCO output frequency, with the phase of a reference signal frequency output pulse is generated in proportion to that phase difference.

- LF (Loop Filter)

LF smooths the output pulse of the phase detector and the resulting DC component is the VCO input.

- VCO (Voltage Controlled Oscillator)

VCO is controlled by loop filter output. The output of the VCO is fed back to the phase frequency detector input for comparison which in turn controls the VCO oscillating frequency to minimize the phase difference.

- FD (Frequency Divider)

FD divides too much different frequency that is oscillated from the VCO to compare it with reference signal frequency.

PLL of the S1D2514X01

PLL is composed of the phase detector, charge pump, VCO, and N-divider as 4 sub-blocks.

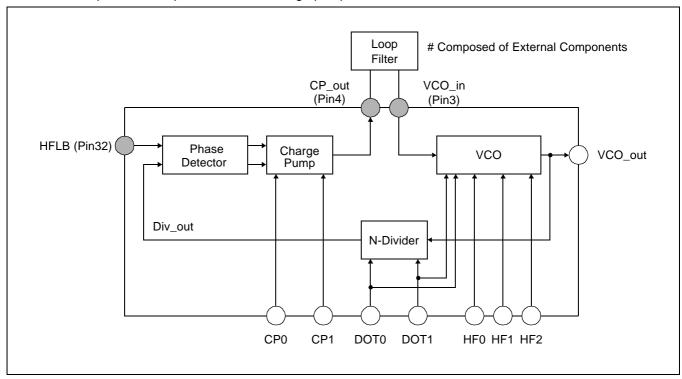


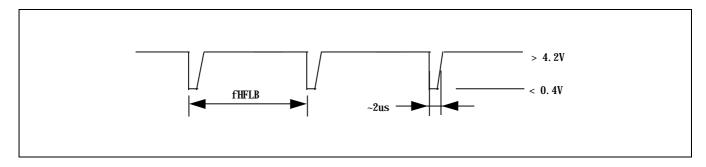
Figure 18. Block Diagram of the PLL Built in S1D2514X01

The following is the description of the input/output signals.

- HFLB (Input)

Horizontal flyback signal is refrence signal of the PLL built in S1D2514X01.

The HFLB signal's frequency range is 15 ~ 90kHz, so the PLL block must be a wide range PLL that can cover HFLB's entire frequency range.



- VCO (Input)

Error signal that passes through an external loop filter is input into VCO.

Operation voltage range is 1-4V. You can raise immunity towards external noise by lowering VCO sensitivity. You can do this by making it have the maximum operation voltage range possible in the 5V power voltage.



- DOT0, 1 (Input)

Mode control signal that controls the number of dots per line in the frame control register. There are 4 modes: 320, 480, 640, and 800 dots/line.

According to your choice of mode, the OSD_PLL block's N-Divider is controlled by one of ÷320, ÷480, ÷640, or ÷800 Divider.

- HF0, 1, 2 (Input)

The horizontal Sync frequency information is received from the micro controller through the frame control registers-1's bit C-A.

- CP0, 1 (Input)

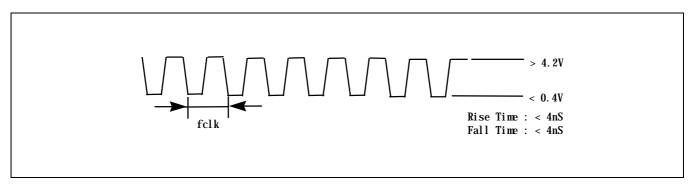
Charge Pump's output sourcing (or sinking) current control pin.

This control data is received through frame control registers-1's bits E-D.

- VCO_OUT (Output)

VCO output that becomes a system clock. It is the OSD R, G, B output signal's dot frequency, and the standard signal for OSD's various timings.

Also, it is input into the N-Divider and makes a PLL loop



- CP OUT (Output)

Charge Pump circuit's output. input into external loop filter. It becomes one of 3 states according to the standard signal input into the phase detector (HFLB) and the divider output (Div_Out).

- HFLB Div_Out is lead: Current sink
- HFLB Lag: Current source
- HFLB In-Phase: High impedence

TUNNING FACTORS OF THE S1D2514X01 PLL

PLL External Circuit

You may follow the recommendations for PCB art work and input/output signal characteristic improvement in recommendation.

The external circuit that has the most influence on S1D2514X01 PLL block operation is pin 3 (VCO_IN) and pin 4 (CP_OUT)'s surrounding circuit. Refer to OSD PLL block.

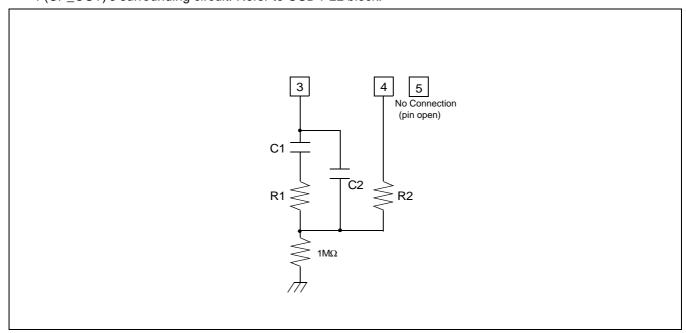


Figure 19. PLL External Circuit

Because the PLL circuit is basically a feedback circuit, there are many components that influence the characteristics. C1, C2, R1, and R2 do not have a localized effect.

As you can see, they are connected to the PLL control bits and influence the characteristics through their complicated relationships. The main functions of the time canstant and their reference values are as follows.

Table 14. Main	Function of	f Time	Constant in	PLL	External Circuit

Time Canstant	Recommended Value	Main Function
C1	10uF	Influences the damping ratio and controls the PLL response time
R1	5.6ΚΩ(7.5ΚΩ)	Same as C1
R2	27KΩ (or 33KΩ)	Charge pump current adjustment
C2	33pF	Removes ripple caused by R-C circuit



PLL Control Bit

After configuring an external circuit using the recommended values, carry out programming using the recommended values for frequency range and control bits given in the Table below.

Table 15. Recommend Values of PLL Control Bit

Register Set	PLL Control Bit								
Freq. Range	CP1	CP0	FPLL	HF2	HF1	HF0	DOT1	DOT0	Hex
Below 40kHz	0	0	0	0	1	0	1	1	0B
40 - 50kHz	1	0	0	1	0	0	1	1	93
50 - 70kHz	1	1	0	1	0	1	1	1	A7
Above 70kHz	1	1	0	1	1	1	1	1	AF

(Ref: 800 × 600, C1: 10uF, R1: 5.6K, R2: 27K, C2: 33pF)

Locking Range

As you can see the figure below, it is 2.35V that measured voltage at pin-3 to optimize OSD quality. The proper voltage range is 1.5 — 3.25V.

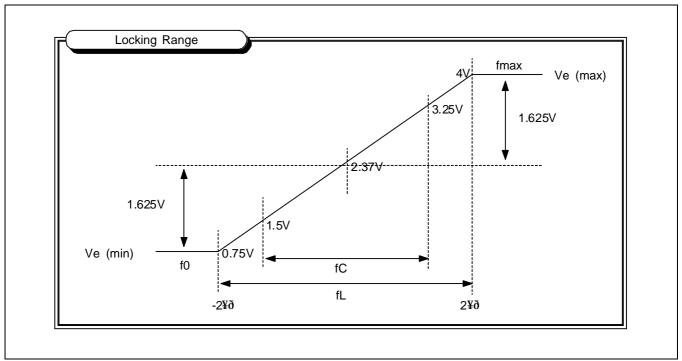


Figure 20. Locking Range

HF Bits Selection

HF bits is not selecting from out of 8 (2^3) steps uniformly, but selecting the step shown in figure below. In example, at 800 mode, there are 5 steps that the frequency range is controlled by HF bits.

Table 16. HF Bits Selection

DIV	DOT1	DOT0	HF2	HF1	HF0
320	0	0			
480	0	1			
640	1	0			
800	1	1			

After fixing time constants of the external circuit and PLL control bits except HF bits, if HF bits are stepped up, the voltage measured at pin-3 drops. On the contrary, if HF bits are stepped down, the voltage rises.

The voltage measured at pin-3 don't change by changing CP bits.

External Register at pin-4

The external register at pin-4 is the factor that changes greatly at PLL tunning. The initial value of this external register value is decided as follows.

At first, the external register is replaced variable-register (about $50K\Omega$ range).

and then, set the lowest PLL control bits at the lowest frequency allowed by set. and then, change variable-register to be 2.35V that optimum voltage is locking. and then, measure register value at this time.

also, set the highest PLL control bits at the highest frequency allowed by set.

and then, change variable-register to be 2.35V that optimum voltage is locking. and then, measure register value at this time.

You may decide the average of these two registers' value to initial value.



The table below shows that other factors change as changing external register's value.

Fixing Factor	Variable Factor	Change	Voltage	Current	Lock Range
Time constants of the external circuit	Rext	1	1	\downarrow	↓ (shift)
and PLL control bits except		\downarrow	\downarrow	1	↑ (shift)

RECOMMENDATION

5V Power Routing

S1D2514X01's OSD part power is composed of analog VDD and digital VDD. To eliminate clock noise influence in the digital block, you need to separate the analog VDDA and digital VDD.

(BD102 use: Refer to Application Circuit)

12V Power Routing

Because S1D2514X01 is a wideband AMP of above 150MHz, 12V power significantly affects the video characteristics. The effects from the inductance and capacitance are different for each board, and , therefore, some tuning is required to obtain the optimum performance. The output power, VCC2, must be separated from VCC1 and VCC3 using a coil, which is parallel-connected to the damping resistor. The appropriate coil value is between 20uH - 200uH. Parallel-connected a variable resistor to the coil and control its resistance to obtain the optimum video waveform.

(Moreover, BD103 can tune using a coil and variable resistor to obtain the optimum video waveform. L103, R124, BD103: Refer to application circuit)

VCC1, VCC3 12V Power

Use a 104 capacitor and large capacitor greater than 470uH for the power filter capacitor.

12V Output Stage Power VCC2

Do not use the power filter capacitor.

5V Digital Power VDD

Don't use a coil or magnetic core to the VDD input. Make the power filter capacitor, an electric capacitor of greater than 50uF, single and connect it to VSS, the digital GND.

Output Stage GND2

Care must be taken during routing because it ,as an AMP output stage GND, is an important factor of video oscillation. R/G/B clamp cap and R/G/B load resistor must be placed as close as possible to the GND2 pin. GND2 must be arranged so that it has the minimum GND loop, which at one point must be connected to the main GND.

Digital GND VSS

When this is to be connected directly to the GND2, it can cause the OSD clock noise, so the loop connection should be routed as far away as possible. If the OSD clock noise affects the screen, separate VSS GND from all GND and connect it to the main board using a bead. Again, the bead connection point should be placed as far away as possible to the GND2.

Analog Block

The PLL built in to S1D2514X01 is sensitive to noise due to the wide range PLL characteristics. Therefore, you need to isolate the analog block in the following manner. First make a separate land for the analog block (pin2 - pin6)'s ground, and connect it to the main ground through a $1M\Omega$ resistor. The analog GND of both sides of a double faced PCB must be separated from the main ground. (Separate pin 2's 5V analog GND, which is the GND for OSD PLL, from the main and digital GNDs and connect it to the main GND using about $1M\Omega$ resistor. GND for pins 2 - 6 is the No. 2 VSSA GND.)



I²C Control Line (SCL, SDA Line)

I²C communication noise (noise generated in the OSD display pattern when data is transmitted in the I²C line) may be generated because of an I²C control line that passes near the analog block. The I²C control lines near S1D2514X01 must be separated from the analog block as much as possible.

Furthermore, the I²C bus interference can be prevented by inserting a series resistor in the line.

Horizontal Flyback Signal

Display jittering can be generated if the horizontal signal (HFLB) input to S1D2514X01 is not a clean signal.

We recommend a short path and shielded cable for obtaining a clean signal.

Generally, the input horizontal signal (HFLB) is generated by using a high voltage horizontal flyback signal. The effect from the high voltage flyback signal can be reduced by separating the R115 and R117 GND, which determines the flyback signal slice level, from the transistor GND, which generates the actual S1D2514X01 input horizontal signal. Furthermore, the flyback signal sharpness must be maintained by minimizing the values of R115, R116 and R117 resistors, which set the horizontal signal slice level. values.

(R115, R116, R117: Refer to application circuit)

HFLB Input Signal Generator

You can correct the circuit by reducing the resistors that sets the slice level of the horizontal signal in the HFLB-generating circuit.



APPLICATION BOARD CIRCUIT

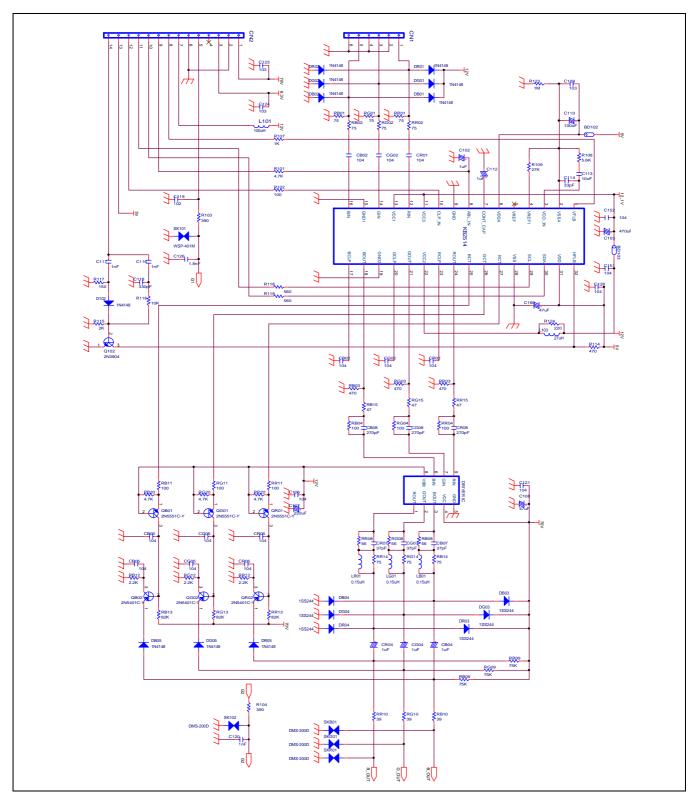


Figure 21. Application Board Circuit



TYPICAL APPLICATION CIRCUIT

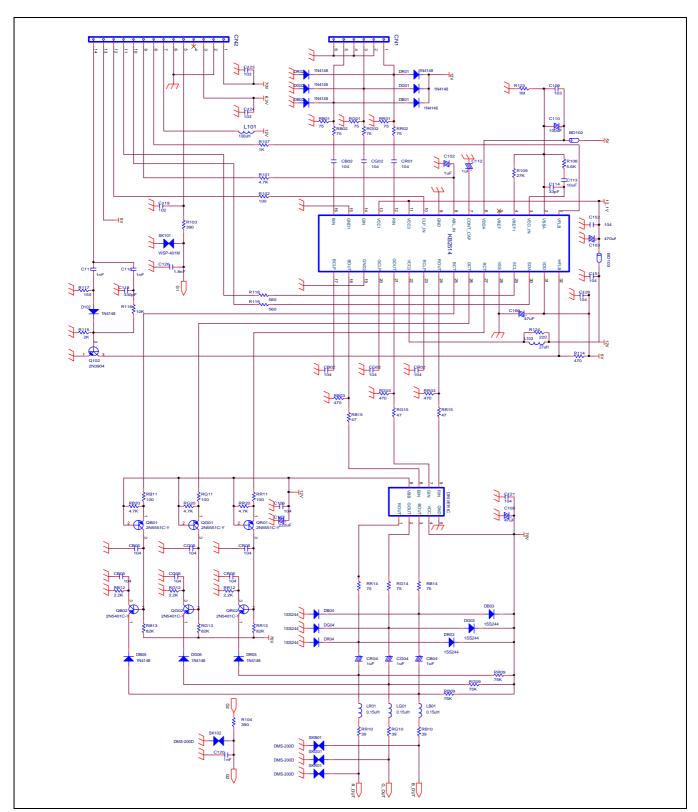


Figure 22. Typical Application Circuit



ROM FONTS

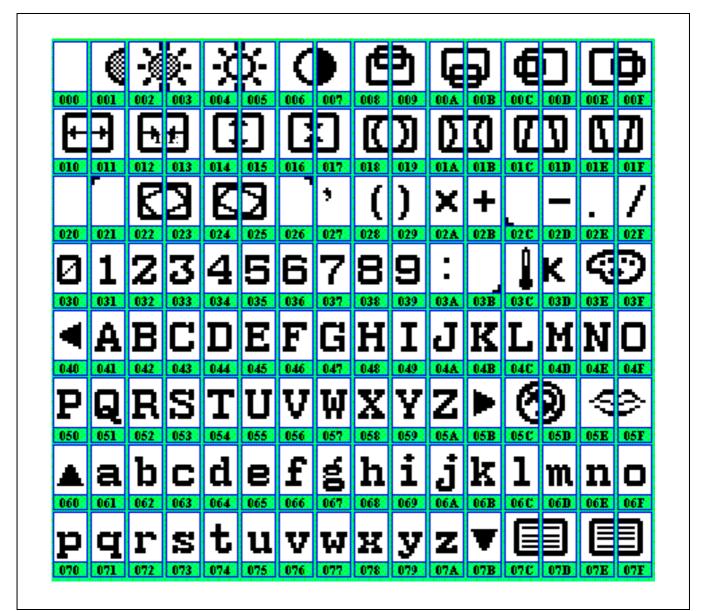


Figure 23. ROM Fonts



